

00043538 073604

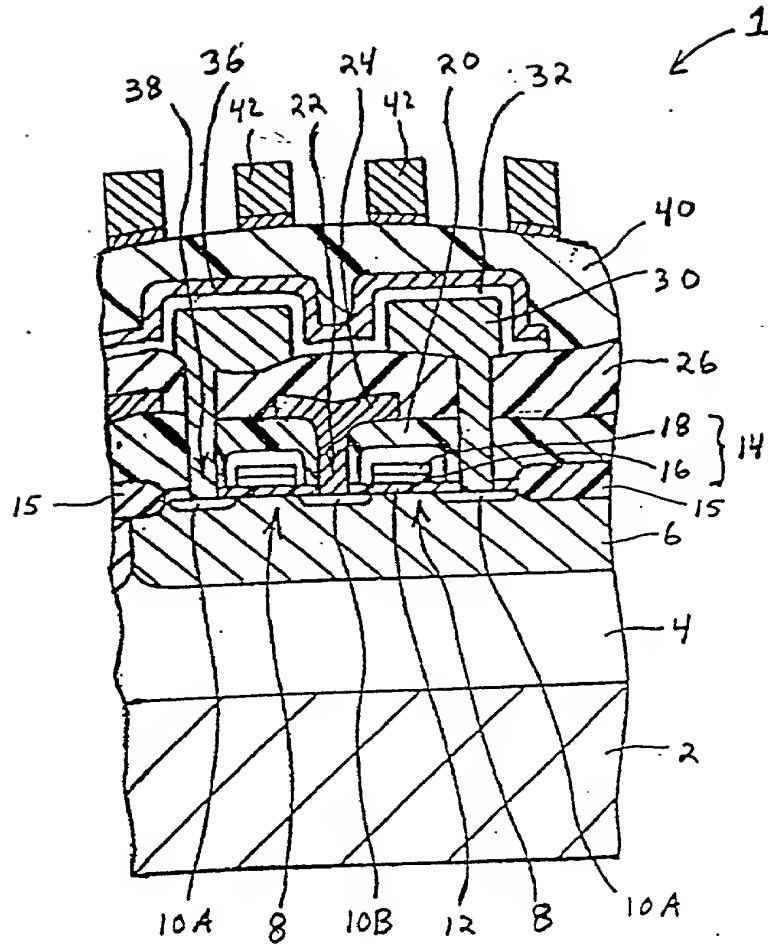


FIG. 1

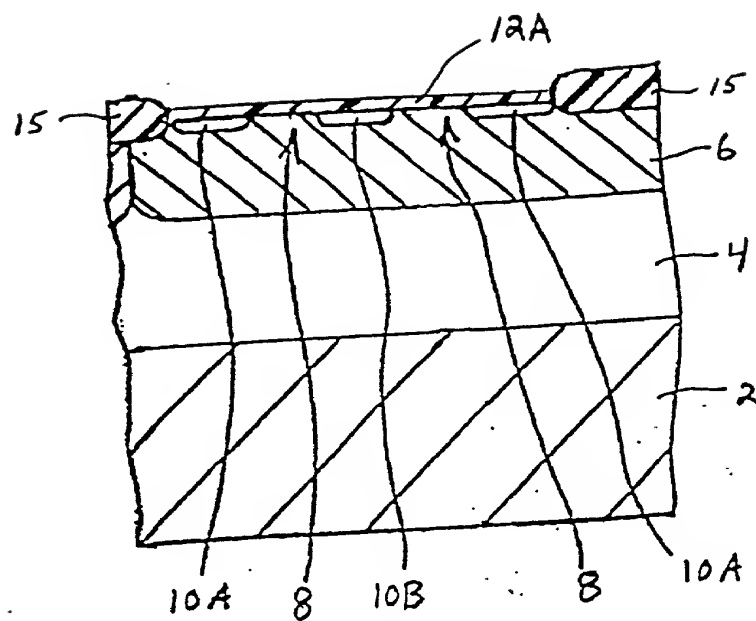


FIG. 2

09943553.072604

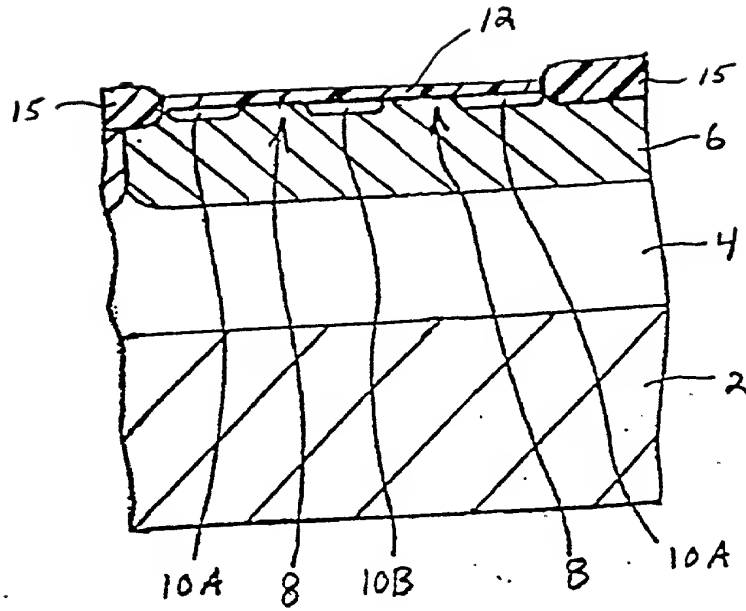


FIG. 3

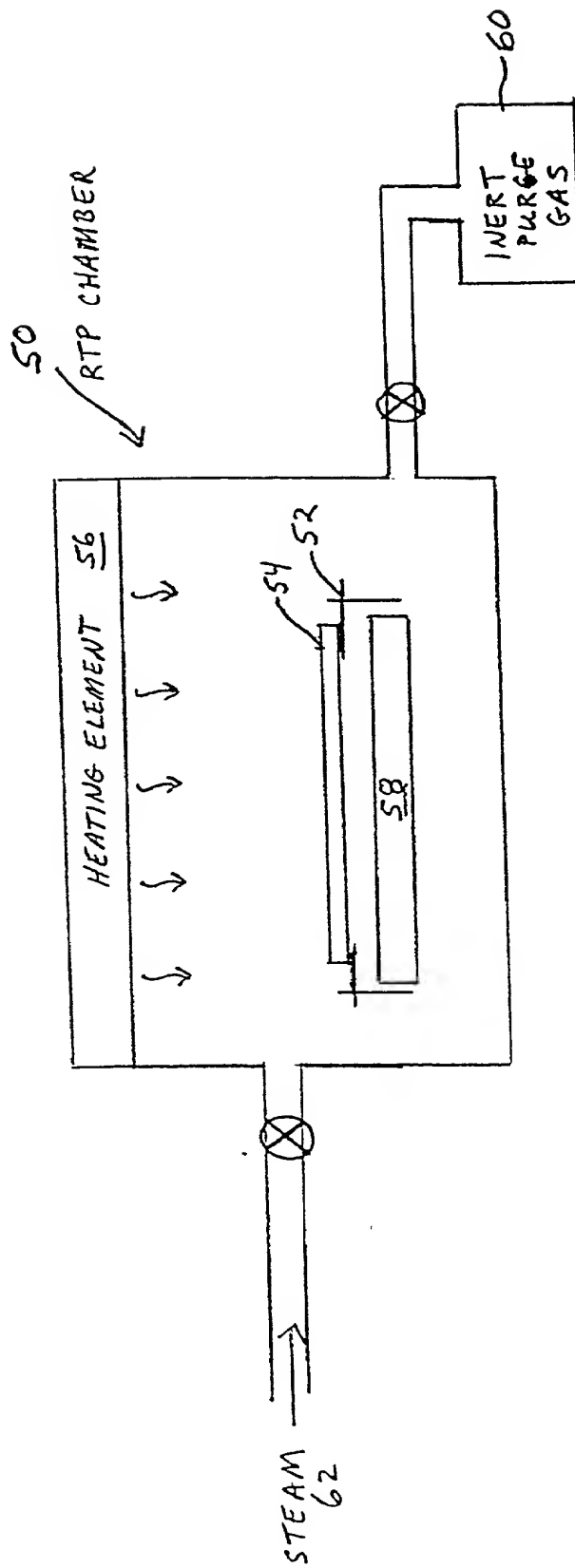


FIG. 4

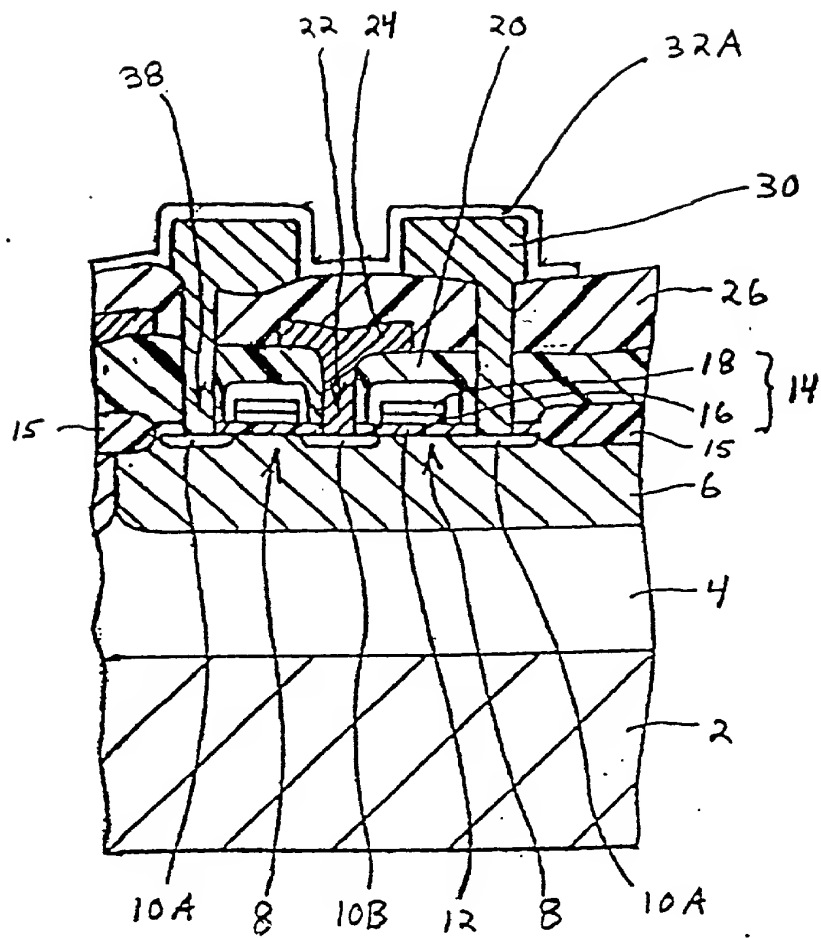


FIG. 5

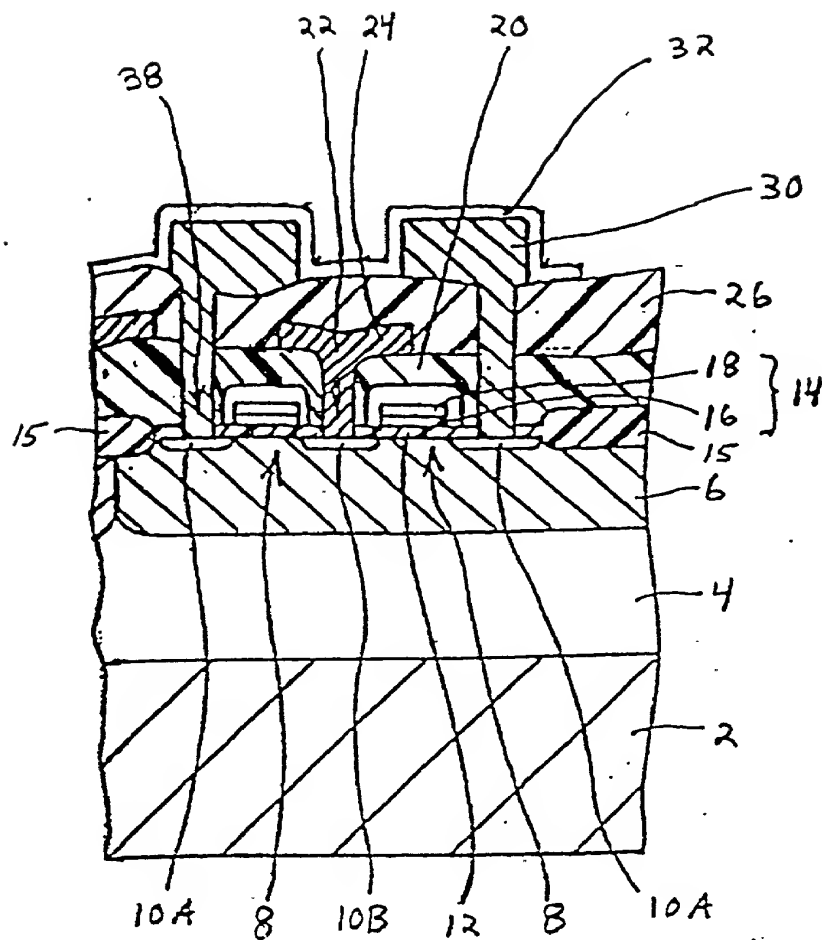


FIG. 6

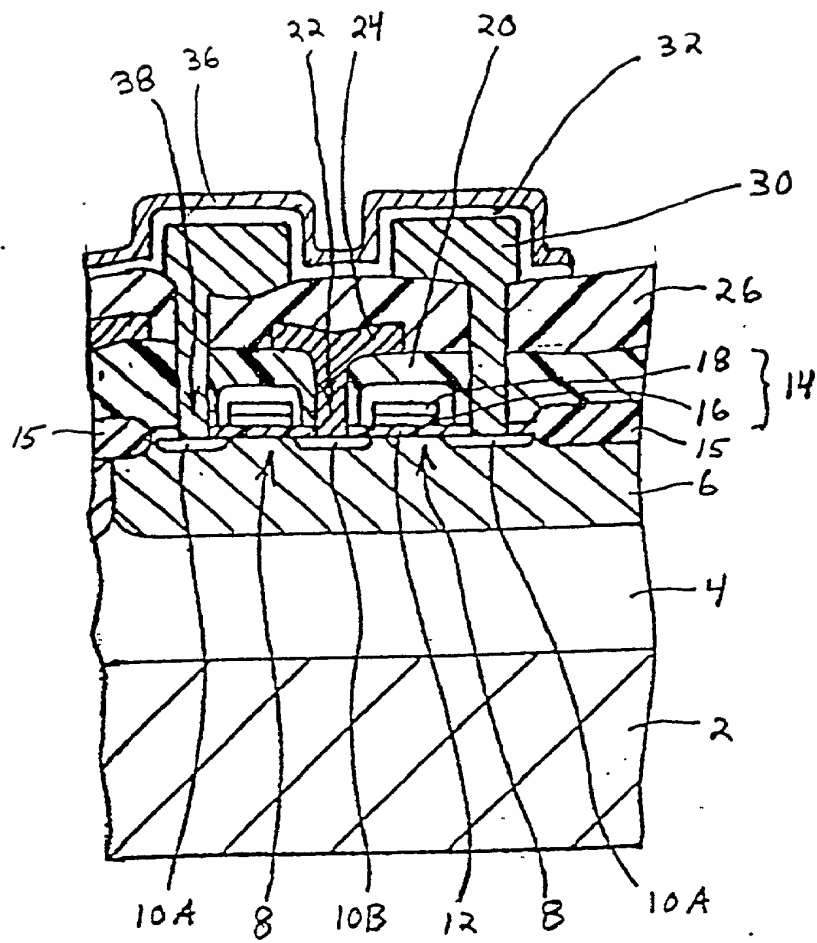


FIG. 7

DEPOSIT DIELECTRIC OR INSULATING FILM



SUBJECT THE INSULATING FILM TO A HEAT TREATMENT IN AN AMBIENT COMPRISING A STABILIZING GAS INCLUDING A GAS SELECTED FROM THE GROUP CONSISTING OF  $N_2$ ,  $O_2$ ,  $O_3$ , NO, OR  $N_2O$



SUBJECT THE INSULATING FILM TO A WET OXIDATION IN A RAPID THERMAL PROCESS (RTP) CHAMBER

FIG. 8

105020 8851550